DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION

As a below named Inventor, I hereby declare that:

DOCKET NO. <u>TS03-0268</u>

My residence, post office address and citizenship are as stated below next to my name;

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if phural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention emitted Method For Improving Interlevel Dielectric Gap Filling Over Semiconductor Structures Having High Aspect Ratios the specification of which (check one)

Y in supply 11		
X is attached hereto,		
was filed on		
said was amended on	· · · · · · · · · · · · · · · · · · ·	
amended by any amendment referre	d to above,	ne above Identified specification including the claims, as
I acknowledge the duty to disclose 37, Code of Federal Regulations, §	information which is material to	the examination of this application in accordance with little
I hereby claim foreign priority benefit inventor's certificate listed below at a filing date before that of the application(s)	its under Title 35, United States d have also identified below any ation on which priority is claime	Code 5110 of any Service
(Number)		Priority Claimed:
	(Country)	(Day/Month/Year Filed)
(Number)	(Country)	(Day/Month/Year Filed)
national or PCT international filing de	regulations, § 1.56(a) which occurred of this application:	any United States application(s) listed below and, insofar closed in the prior United States application in the marner I acknowledge the duty to disclose material information as used between the filing date of the prior application and the s) (parented, pending, abandoned)
I hereby declare that all statements me	ade berein of my own knowledge	are true and that all statements made on information and ade with the knowledge that willful false statements and r Section 1001 of Title 18 of the United States Code and lication or any patent issued thereon.
POWER OF ATTORNEY: As a name application and transact all business in	ed inventor, I hereby appoint the	following anormey(s) and/or agent(s) to prosecute this
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